

LM137JAN 3-Terminal Adjustable Negative Regulators

Check for Samples: [LM137JAN](#)

FEATURES

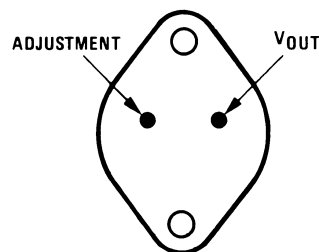
- Output Voltage Adjustable from $-37V$ to $-1.2V$
- 1.5A Output Current Specified, $-55^{\circ}C$ to $+150^{\circ}C$
- Line Regulation Typically 0.01%/V
- Load Regulation Typically 0.3%
- Excellent Thermal Regulation, 0.002%/W
- 77 dB Ripple Rejection
- Excellent Rejection of Thermal Transients
- 50 ppm/ $^{\circ}C$ Temperature Coefficient
- Temperature-independent Current Limit
- Internal Thermal Overload Protection
- Standard 3-lead Transistor Package
- Output is Short Circuit Protected

DESCRIPTION

The LM137 are adjustable 3-terminal negative voltage regulators capable of supplying in excess of $-1.5A$ over an output voltage range of $-37V$ to $-1.2V$. These regulators are exceptionally easy to apply, requiring only 2 external resistors to set the output voltage and 1 output capacitor for frequency compensation. The circuit design has been optimized for excellent regulation and low thermal transients. Further, the LM137 series features internal current limiting, thermal shutdown and safe-area compensation, making them virtually blowout-proof against overloads.

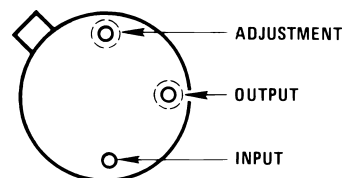
The LM137 serves a wide variety of applications including local on-card regulation, programmable-output voltage regulation or precision current regulation. The LM137 are ideal complements to the LM117 adjustable positive regulators.

Connection Diagram



Case Is Input

**Figure 1. TO-3
Metal Can Package
Bottom View
See Package Number K0002C**



Case Is Input

**Figure 2. TO
Metal Can Package
Bottom View
See Package Number NDT0003A**

Table 1. LM137 Series Packages and Power Capability

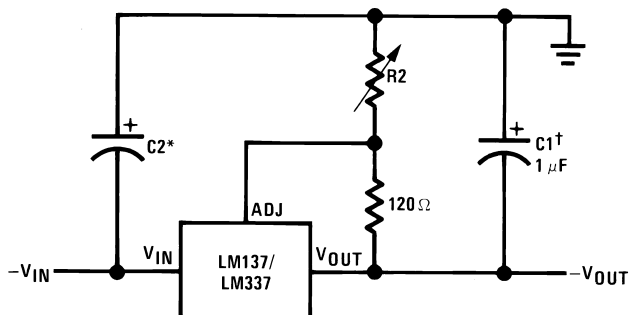
Device	Package	Rated Power Dissipation	Design Load Current
LM137	TO-3 (K)	20W	1.5A
	TO (NDT)	2W	0.5A



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Typical Applications



Full output current not available at high input-output voltages

$$-V_{OUT} = -1.25V \left(1 + \frac{R_2}{120} \right) + (-I_{ADJ} \times R_2)$$

†C1 = 1 μ F solid tantalum or 10 μ F aluminum electrolytic required for stability

*C2 = 1 μ F solid tantalum is required only if regulator is more than 4" from power-supply filter capacitor

Output capacitors in the range of 1 μ F to 1000 μ F of aluminum or tantalum electrolytic are commonly used to provide improved output impedance and rejection of transients

Figure 3. Adjustable Negative Voltage Regulator



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings⁽¹⁾

Power Dissipation ⁽²⁾		Internally Limited
Input-Output Voltage Differential		40V
Operating Ambient Temperature Range		$-55^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$
Operating Junction Temperature Range		$-55^{\circ}\text{C} \leq T_J \leq +150^{\circ}\text{C}$
Maximum Junction Temperature		+150°C
Storage Temperature		$-65^{\circ}\text{C} \leq T_A \leq +150^{\circ}\text{C}$
Lead Temperature (Soldering, 10 sec.)		300°C
Minimum Input Voltage		-41.25V
Maximum Power Dissipation (@25°C)	TO-3	28 Watts
	TO	2.5Watts
Thermal Resistance		
θ_{JA}	TO-3 Metal Can (Still Air)	40°C/W
	TO-3 Metal Can (500LF/Min Air Flow)	14°C/W
	TO Metal Can (Still Air @ 0.5W)	174°C/W
	TO Metal Can (500LF/Min Air Flow @ 0.5W)	64°C/W
θ_{JC}	TO-3	4°C/W
	TO Metal Can (@ 1.0W)	15°C/W
Package Weight (typical)	TO-3	12,750mg
	TO Metal Can	955mg
ESD Rating ⁽³⁾		4K Volts

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- (2) The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{Jmax} (maximum junction temperature), θ_{JA} (package junction to ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $P_{Dmax} = (T_{Jmax} - T_A)/\theta_{JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower.
- (3) Human body model, 100pF discharged through 1.5KΩ

Table 2. Recommended Operating Conditions

T_A	$-55^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$
Input Voltage Range	-41.25V to -4.25V

Quality Conformance Inspection

Mil-Std-883, Method 5005 — Group A

Subgroup	Description	Temp (°C)
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55

LM137H Electrical Characteristics DC Parameters

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
V_{OUT}	Output Voltage	$V_{IN} = -4.25V, I_L = 5mA$		-1.275	-1.225	V	1
				-1.3	-1.2	V	2, 3
		$V_{IN} = -4.25V, I_L = 500mA$		-1.275	-1.225	V	1
				-1.3	-1.2	V	2, 3
		$V_{IN} = -41.25V, I_L = 5mA$		-1.275	-1.225	V	1
				-1.3	-1.2	V	2, 3
$V_{R Line}$	Line Regulation	$V_{IN} = -41.25V \text{ to } -4.25V, I_L = 5mA$		-9.0	9.0	mV	1
				-23	23	mV	2, 3
$V_{R Load}$	Load Regulation	$V_{IN} = -6.25V, I_L = 5mA \text{ to } 500mA$		-12	12	mV	1
				-24	24	mV	2, 3
		$V_{IN} = -41.25V, I_L = 5mA \text{ to } 50mA$		-6.0	6.0	mV	1
				-12	12	mV	2, 3
		$V_{IN} = -6.25V, I_L = 5mA \text{ to } 200mA$		-6.0	6.0	mV	1
				-12	12	mV	2, 3
V_{Rth}	Thermal Regulation	$V_{IN} = -14.6V, I_L = 500mA$		-5.0	5.0	mV	1
I_{Adj}	Adjust Pin Current	$V_{IN} = -4.25V, I_L = 5mA$		25	100	μA	1, 2, 3
		$V_{IN} = -41.25V, I_L = 5mA$		25	100	μA	1, 2, 3
$\Delta I_{Adj} / V_{Line}$	Adjust Pin Current Change vs. Line Voltage	$V_{IN} = -41.25V \text{ to } -4.25V, I_L = 5mA$		-5.0	5.0	μA	1, 2, 3
$\Delta I_{Adj} / I_{Load}$	Adjust Pin Current Change vs. Load Current	$V_{IN} = -6.25V, I_L = 5mA \text{ to } 500mA$		-5.0	5.0	μA	1, 2, 3
I_{OS}	Output Short Circuit Current	$V_{IN} = -4.25V$		0.5	1.8	A	1, 2, 3
		$V_{IN} = -40V$		0.05	0.5	A	1, 2, 3
$V_{OUT Recovery}$	Output Voltage Recovery After Output Short Circuit Current	$V_{IN} = -4.25V$		-1.275	-1.225	V	1
					-1.3	-1.2	V
		$V_{IN} = -40V$		-1.275	-1.225	V	1
					-1.3	-1.2	V

LM137H Electrical Characteristics DC Parameters (continued)

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
I _Q	Minimum Load Current	V _{IN} = -4.25V		0.2	3.0	mA	1, 2, 3
		V _{IN} = -14.25V		0.2	3.0	mA	1, 2, 3
		V _{IN} = -41.25V		1.0	5.0	mA	1, 2, 3
V _{Start}	Voltage Start-up	V _{IN} = -4.25V, I _L = 500mA		-1.275	-1.225	V	1
				-1.3	-1.2	V	2, 3
V _{OUT}	Output Voltage	V _{IN} = -6.25V, I _L = 5mA (No Subgroup)	(1)	-1.3	-1.2	V	

(1) Tested at +125°C ; correlated to +150°C

LM137H Electrical Characteristics A Parameters

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
$\frac{\Delta V_{IN}}{\Delta V_{OUT}}$	Ripple Rejection	V _{IN} = -6.25V, I _L = 125mA, e ₁ = 1V _{RMS} at 2400Hz		48		dB	4
V _{NO}	Output Noise Voltage	V _{IN} = -6.25V, I _L = 50mA			120	μV _{RMS}	
$\frac{\Delta V_{OUT}}{\Delta V_{IN}}$	Line Transient Response	V _{IN} = -6.25V, V _{Pulse} = -1V, I _L = 50mA			80	mV/V	7
$\frac{\Delta V_{OUT}}{\Delta I_L}$	Load Transient Response	V _{IN} = -6.25V, I _L = 50mA, ΔI _L = 200mA	(1)		60	mV	7

(1) Slash sheet limit of 0.3mV/mA is equivalent to 60mV

LM137H Electrical Characteristics DC Parameters: Drift Values

Delta calculations performed on JAN S devices at group B, subgroup 5 only.

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
V _{OUT}	Output Voltage	V _{IN} = -4.25V, I _L = 5mA		-0.01	0.01	V	1
		V _{IN} = -4.25V, I _L = 500mA		-0.01	0.01	V	1
		V _{IN} = -41.25V, I _L = 5mA		-0.01	0.01	V	1
		V _{IN} = -41.25V, I _L = 50mA		-0.01	0.01	V	1
V _{R Line}	Line Regulation	V _{IN} = 41.25V to -4.25V, I _L = 5mA		-4.0	4.0	mV	1
I _{Adj}	Adjust Pin Current	V _{IN} = -4.25V, I _L = 5mA		-10	10	μA	1
		V _{IN} = -41.25V, I _L = 5mA		-10	10	μA	1

LM137K Electrical Characteristics DC Parameters

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
V _{OUT}	Output Voltage	V _{IN} = -4.25V, I _L = 5mA		-1.275	-1.225	V	1
				-1.3	-1.2	V	2, 3
		V _{IN} = -4.25V, I _L = 1.5A		-1.275	-1.225	V	1
				-1.3	-1.2	V	2, 3
		V _{IN} = -41.25V, I _L = 5mA		-1.275	-1.225	V	1
				-1.3	-1.2	V	2, 3
V _{IN} = -41.25V, I _L = 200mA		-1.275	-1.225	V	1		
		-1.3	-1.2	V	2, 3		
V _{R Line}	Line Regulation	-41.25V ≤ V _{IN} ≤ -4.25V, I _L = 5mA		-9.0	9.0	mV	1
				-23	23	mV	2, 3
V _{R Load}	Load Regulation	V _{IN} = -6.25V, I _L = 5mA to 1.5A		-6.0	6.0	mV	1
				-12	12	mV	2, 3
		V _{IN} = -41.25V, I _L = 5mA to 200mA		-6.0	6.0	mV	1
				-12	12	mV	2, 3
V _{Rth}	Thermal Regulation	V _{IN} = -14.6V, I _L = 1.5A		-5.0	5.0	mV	1
I _{Adj}	Adjust Pin Current	V _{IN} = -4.25V, I _L = 5mA		25	100	μA	1, 2, 3
		V _{IN} = -41.25V, I _L = 5mA		25	100	μA	1, 2, 3
ΔI _{Adj} / V _{Line}	Adjust Pin Current Change vs. Line Voltage	-41.25V ≤ V _{IN} ≤ -4.25V, I _L = 5mA		-5.0	5.0	μA	1, 2, 3
ΔI _{Adj} / I _{Load}	Adjust Pin Current Change vs. Load Current	V _{IN} = -6.25V, I _L = 5mA to 1.5A		-5.0	5.0	μA	1, 2, 3
I _{OS}	Output Short Circuit Current	V _{IN} = -4.25V		1.5	3.5	A	1, 2, 3
		V _{IN} = -40V		0.2	1.0	A	1, 2, 3
V _{OUT Recovery}	Output Voltage Recovery	V _{IN} = -4.25V		-1.275	-1.225	V	1
				-1.3	-1.2	V	2, 3
		V _{IN} = -40V		-1.275	-1.225	V	1
				-1.3	-1.2	V	2, 3
I _Q	Minimum Load Current	V _{IN} = -4.25V		0.2	3.0	mA	1, 2, 3
		V _{IN} = -14.25V		0.2	3.0	mA	1, 2, 3
		V _{IN} = -41.25V		1.0	5.0	mA	1, 2, 3
V _{Start}	Voltage Start-up	V _{IN} = 4.25V, I _L = 1.5A		-1.275	-1.225	V	1
		V _{IN} = 4.25V, I _L = 1.5A		-1.3	-1.2	V	2, 3
V _{OUT}	Output Voltage	V _{IN} = -6.25V, I _L = 5mA No Subgroup	(1)	-1.3	-1.2	V	

(1) Tested at +125°C ; correlated to +150°C

LM137K Electrical Characteristics AC Parameters

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
$\Delta V_{IN} / \Delta V_{OUT}$	Ripple Rejection	$V_{IN} = -6.25V, I_L = 500mA, e_1 = 1V_{RMS}$ at 2400Hz		50		dB	4
V_{NO}	Output Noise Voltage	$V_{IN} = -6.25V, I_L = 100mA$			120	μV_{RMS}	
$\Delta V_{OUT} / \Delta V_{IN}$	Line Transient Response	$V_{IN} = -6.25V, I_L = 100mA, V_{Pulse} = -1V$			80	mV/V	7
$\Delta V_{OUT} / \Delta I_L$	Load Transient Response	$V_{IN} = -6.25V, I_L = 100mA, \Delta I_L = 400mA$	(1)		60	mV	7

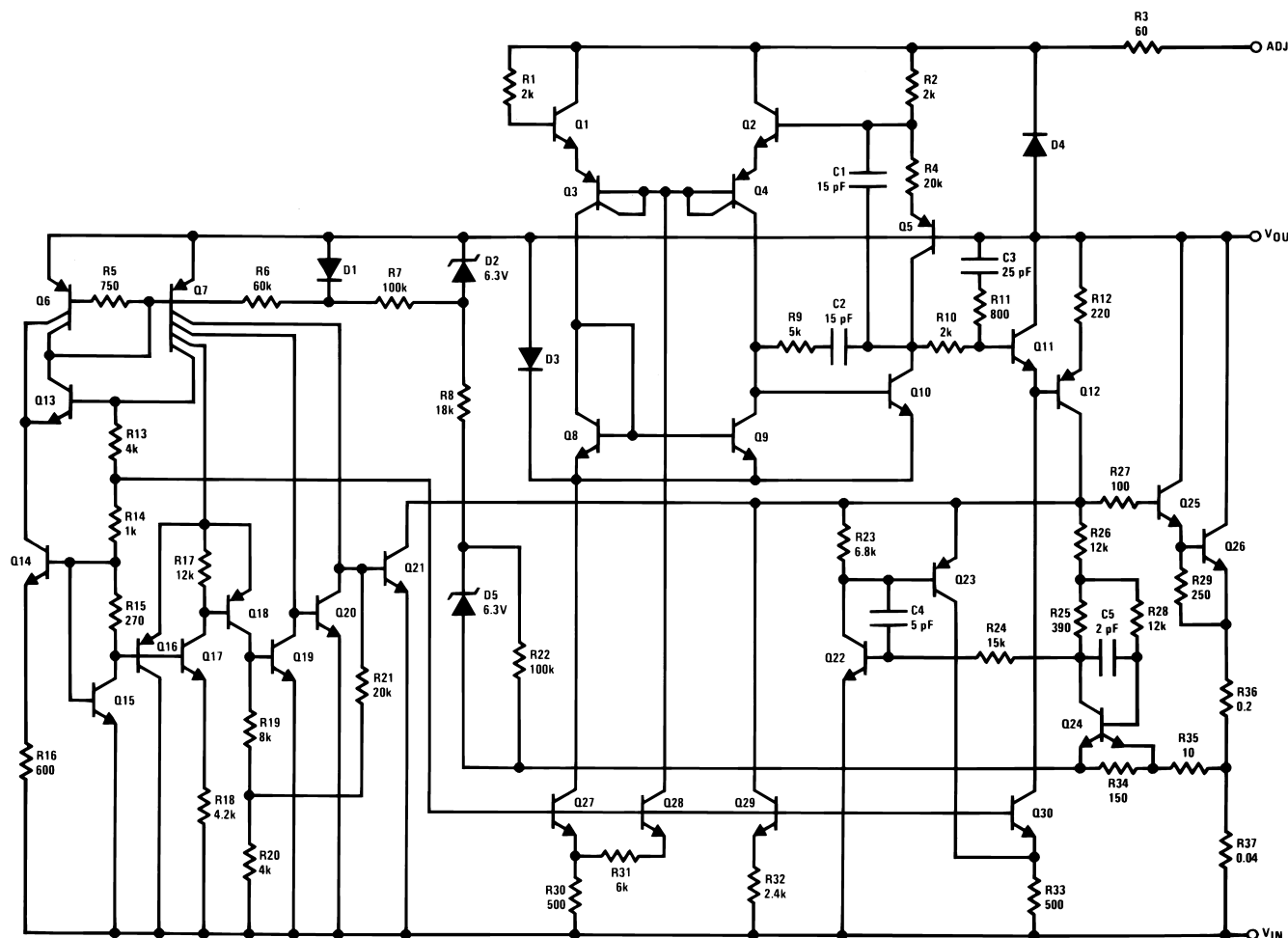
(1) Slash sheet limit of 0.15mV/mA is equivalent to 60mV

LM137K Electrical Characteristics DC Parameters: Drift Values

Delta calculations performed on JAN S devices at group B, subgroup 5 only.

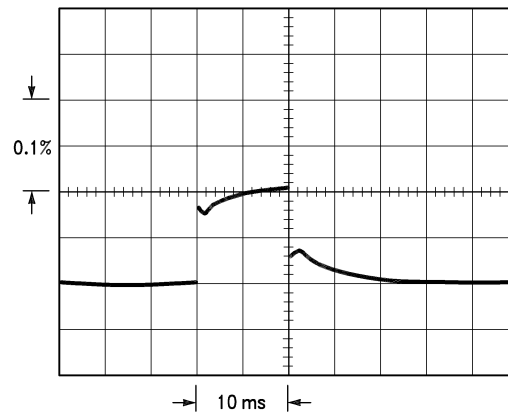
Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
V_{OUT}	Output Voltage	$V_{IN} = -4.25V, I_L = 5mA$		-0.01	0.01	V	1
$V_{R\ line}$	Line Regulation	$V_{IN} = -41.25V$ to $-4.25, I_L = 5mA$		-4.0	4.0	mV	1
I_{Adj}	Adjust Pin Current	$V_{IN} = -41.25V, I_L = 5mA$		-10	10	μA	1

Schematic Diagram



Thermal Regulation

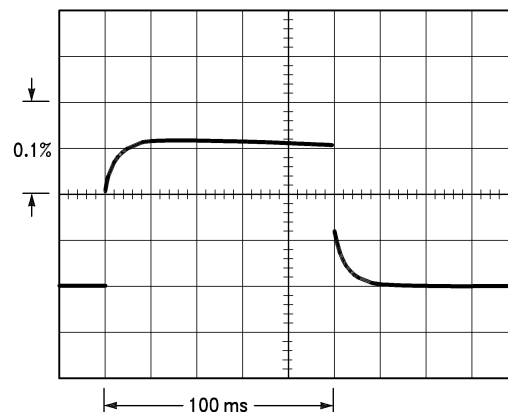
When power is dissipated in an IC, a temperature gradient occurs across the IC chip affecting the individual IC circuit components. With an IC regulator, this gradient can be especially severe since power dissipation is large. Thermal regulation is the effect of these temperature gradients on output voltage (in percentage output change) per Watt of power change in a specified time. Thermal regulation error is independent of electrical regulation or temperature coefficient, and occurs within 5 ms to 50 ms after a change in power dissipation. Thermal regulation depends on IC layout as well as electrical design. The thermal regulation of a voltage regulator is defined as the percentage change of V_{OUT} , per Watt, within the first 10 ms after a step of power is applied. The LM137's specification is 0.02%/W, max.



LM137, $V_{OUT} = -10V$
 $V_{IN} - V_{OUT} = -40V$
 $I_{IL} = 0A \rightarrow 0.25A \rightarrow 0A$
 Vertical sensitivity, 5 mV/div

Figure 4.

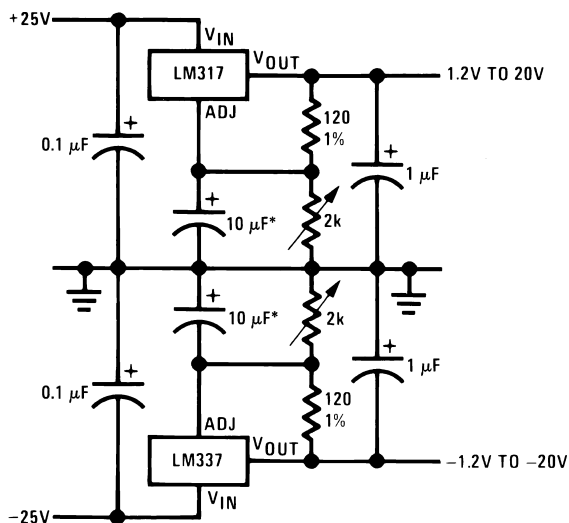
In [Figure 4](#), a typical LM137's output drifts only 3 mV (or 0.03% of $V_{OUT} = -10V$) when a 10W pulse is applied for 10 ms. This performance is thus well inside the specification limit of $0.02\%/W \times 10W = 0.2\%$ max. When the 10W pulse is ended, the thermal regulation again shows a 3 mV step as the LM137 chip cools off. Note that the load regulation error of about 8 mV (0.08%) is additional to the thermal regulation error. In [Figure 5](#), when the 10W pulse is applied for 100 ms, the output drifts only slightly beyond the drift in the first 10 ms, and the thermal error stays well within 0.1% (10 mV).



LM137, $V_{OUT} = -10V$
 $V_{IN} - V_{OUT} = -40V$
 $I_L = 0A \rightarrow 0.25A \rightarrow 0A$
 Horizontal sensitivity, 20 ms/div

Figure 5.

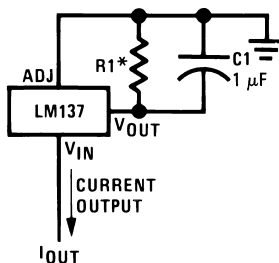
Typical Applications



Full output current not available at high input-output voltages

*The 10 μF capacitors are optional to improve ripple rejection

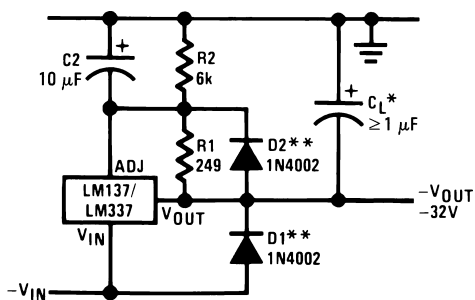
Figure 6. Adjustable Lab Voltage Regulator



$$I_{OUT} = \frac{1.250V}{R1}$$

*0.8Ω ≤ R1 ≤ 120Ω

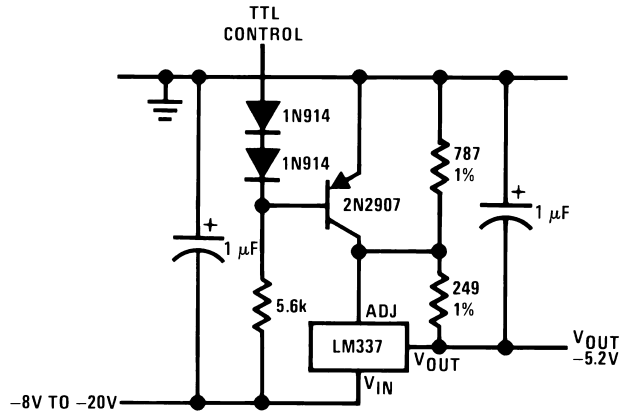
Figure 7. Current Regulator



*When CL is larger than 20 μF, D1 protects the LM137 in case the input supply is shorted

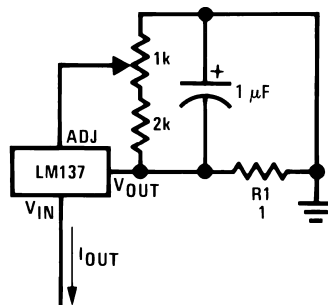
**When C2 is larger than 10 μF and -VOUT is larger than -25V, D2 protects the LM137 in case the output is shorted

Figure 8. Negative Regulator with Protection Diodes



*Minimum output \approx -1.3V when control input is low

Figure 9. -5.2V Regulator with Electronic Shutdown*



$$I_{OUT} = \left(\frac{1.5V}{R_1} \right) \pm 15\% \text{ adjustable}$$

Figure 10. Adjustable Current Regulator

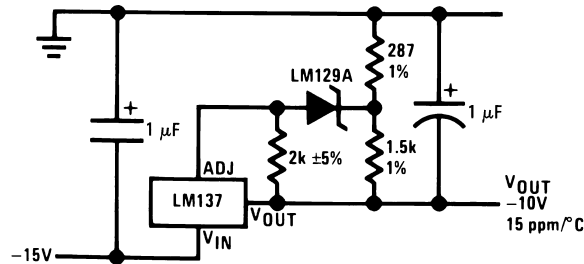


Figure 11. High Stability -10V Regulator

Typical Performance Characteristics

(H & K Packages)

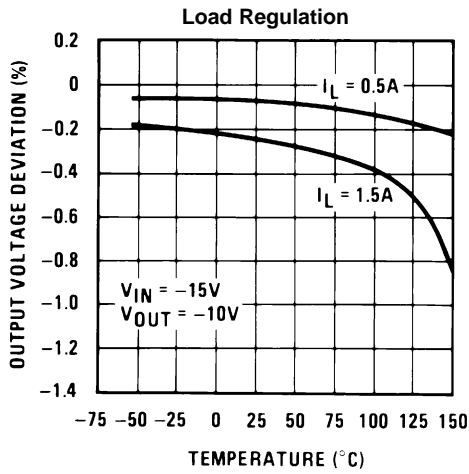


Figure 12.

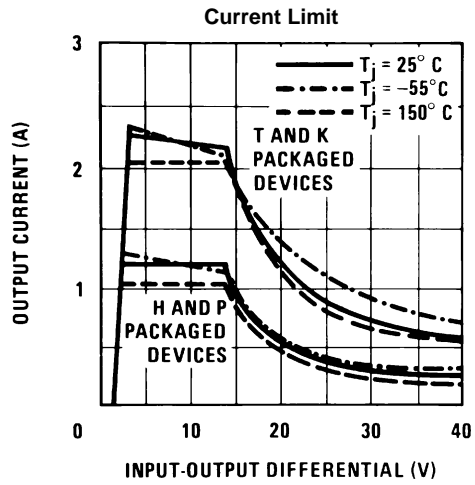


Figure 13.

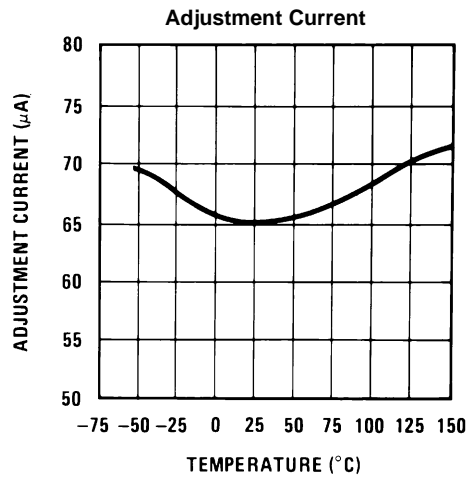


Figure 14.

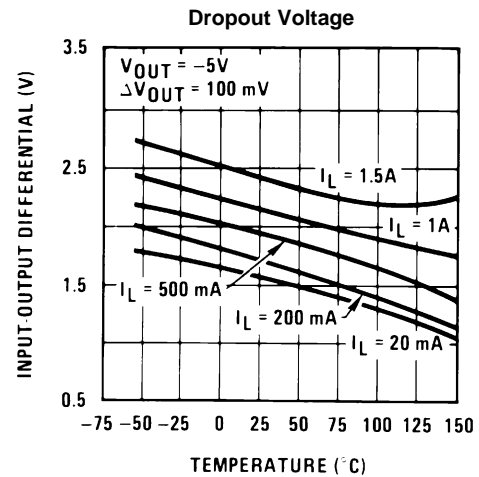


Figure 15.

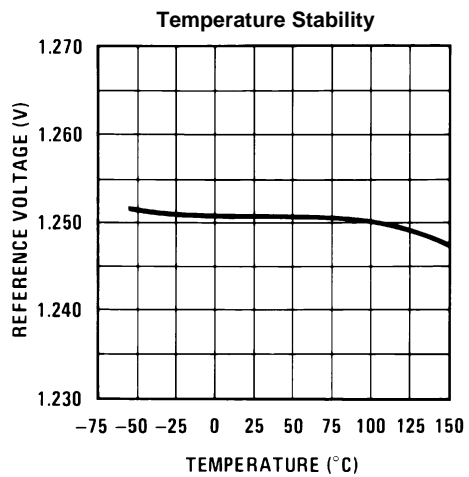


Figure 16.

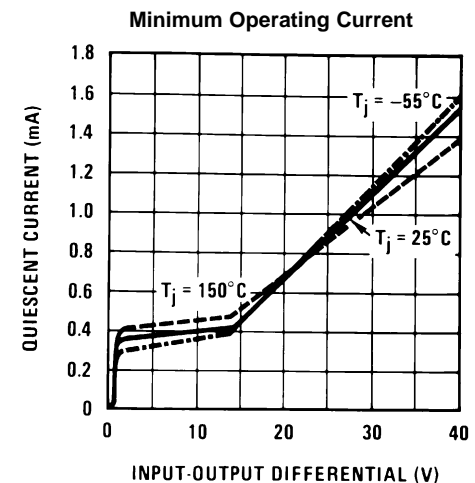


Figure 17.

Typical Performance Characteristics (continued)

(H & K Packages)

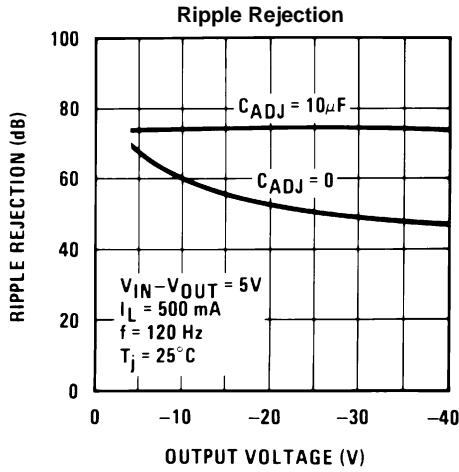


Figure 18.

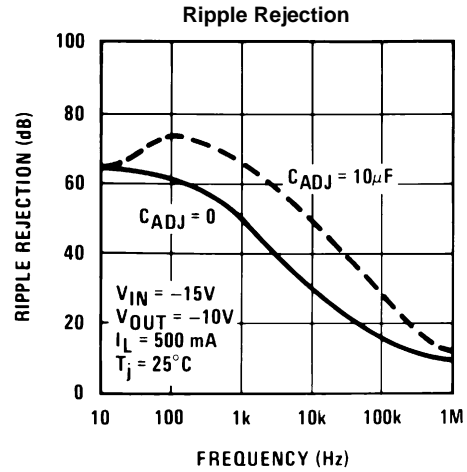


Figure 19.

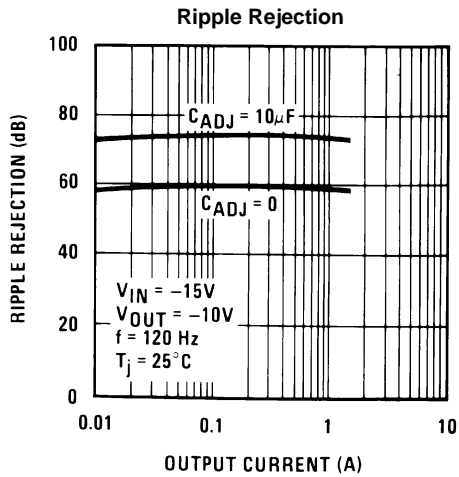


Figure 20.

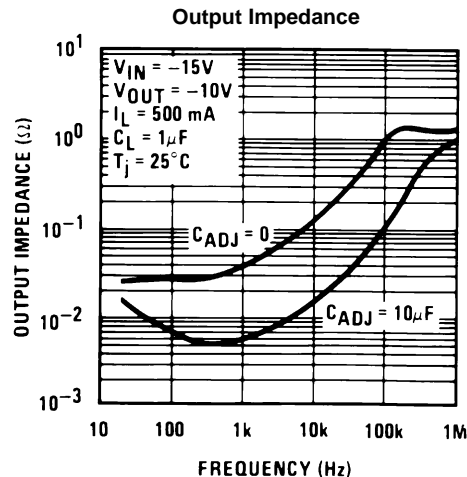


Figure 21.

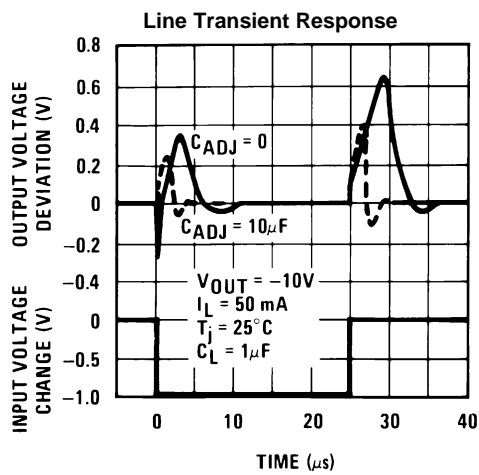


Figure 22.

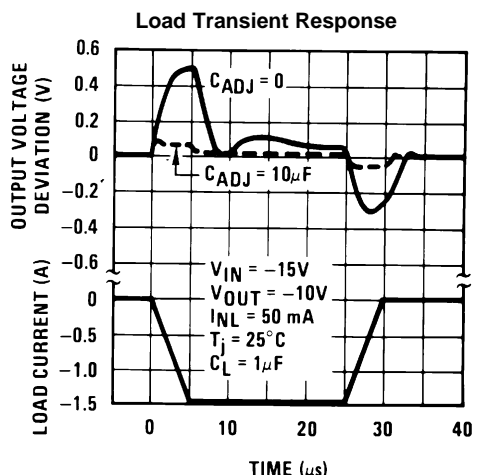


Figure 23.

REVISION HISTORY

Date Released	Revision	Section	Changes
12/08/2010	A	New Release, Corporate format	2 MDS data sheets converted into one Corp. data sheet format. MJLM137-H Rev. 0A0, MJLM137-K Rev. 0A0. MDS data sheets will be archived.
03/20/2013	A	All	Changed layout of National Data Sheet to TI format

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
JL137BXA	ACTIVE	TO	NDT	3	20	TBD	Call TI	Call TI	-55 to 150	JL137BXA JM38510/11803BXA Q ACO JM38510/11803BXA Q >T	Samples
JL137SYA	ACTIVE	TO	K	2	50	TBD	Call TI	Call TI	-55 to 150	JL137SYA Q JM38510/ 11804SYA ACO 11804SYA >T	Samples
JM38510/11803BXA	ACTIVE	TO	NDT	3	20	TBD	Call TI	Call TI	-55 to 150	JL137BXA JM38510/11803BXA Q ACO JM38510/11803BXA Q >T	Samples
JM38510/11804SYA	ACTIVE	TO	K	2	50	TBD	Call TI	Call TI	-55 to 150	JL137SYA Q JM38510/ 11804SYA ACO 11804SYA >T	Samples
M38510/11803BXA	ACTIVE	TO	NDT	3	20	TBD	Call TI	Call TI	-55 to 150	JL137BXA JM38510/11803BXA Q ACO JM38510/11803BXA Q >T	Samples
M38510/11803BXX	ACTIVE	TO	NDT	3	20	TBD	Call TI	Call TI	-55 to 150	JL137BXA JM38510/11803BXA Q ACO JM38510/11803BXA Q >T	Samples
M38510/11804SYA	ACTIVE	TO	K	2	50	TBD	Call TI	Call TI	-55 to 150	JL137SYA Q JM38510/ 11804SYA ACO 11804SYA >T	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF LM137JAN, LM137JAN-SP :

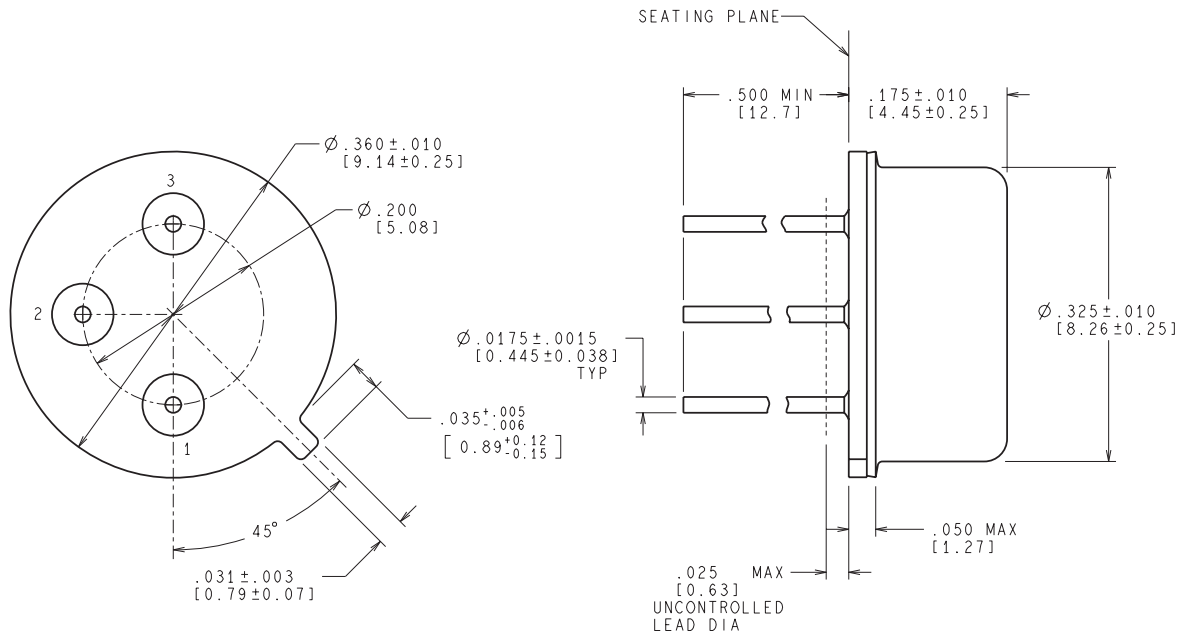
- Military: [LM137JAN](#)
- Space: [LM137JAN-SP](#)

NOTE: Qualified Version Definitions:

- Military - QML certified for Military and Defense Applications

- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

NDT0003A

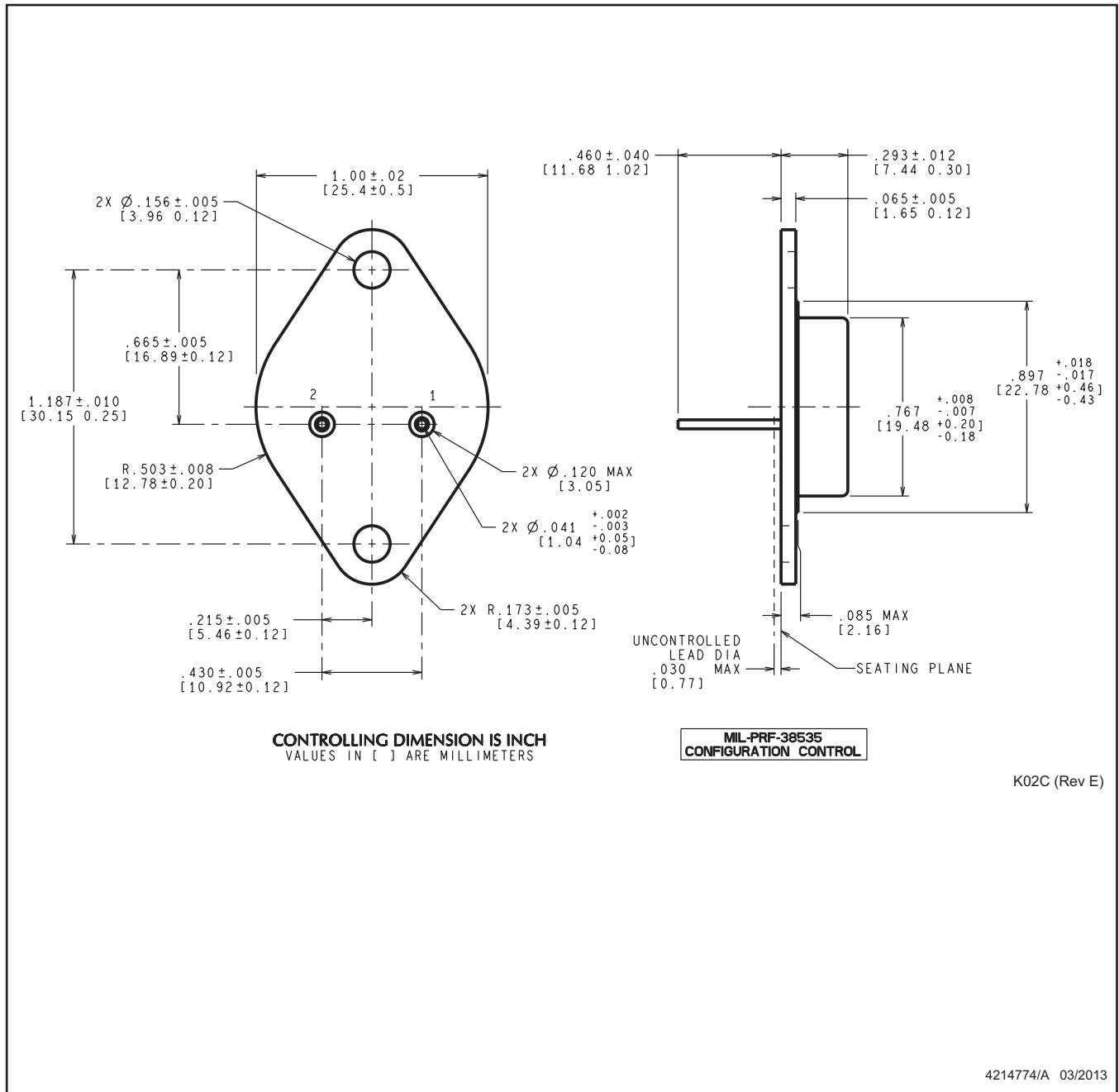


CONTROLLING DIMENSION IS INCH
VALUES IN [] ARE MILLIMETERS

MIL-PRF-38535
CONFIGURATION CONTROL

H03A (Rev D)

K0002C



NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Leads not to be bent greater than 15°

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